

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Hideto SUGAWARA et al.

Serial No: Not assigned

Filed: March 23, 2004

For: Group-III Nitride Semiconductor Stack, Method of Manufacturing
the Same, and Group-III Nitride Semiconductor Device

Art Unit: Not assigned

Examiner: Not assigned

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Hogan & Hartson, LLP
500 South Grand Avenue, Suite 1900
Los Angeles, California 90071
Telephone: 213-337-6700
Facsimile: 213-337-6701

Reynaldo Gallardo

Name of person mailing papers

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